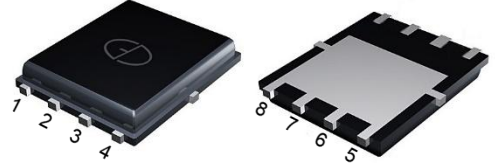


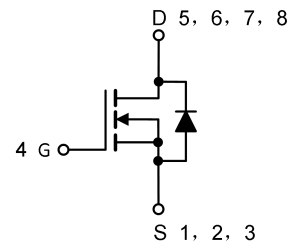
N-Channel 30V (D-S) Power MOSFET

Features

- 100% Avalanche Tested
- Extremely Low Losses with Low FOM $R_{ds(on)} \cdot Q_g$
- Halogen Free, Pb-Free
- RoHS Compliant



PDFN5060



Applications

- DC-DC
- Motors, lamps
- Power switching

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain Source Voltage	V_{DS}	30	V
Gate Source Voltage	V_{GS}	± 20	V
Drain Current, Continuous $V_{GS}=10\text{V}$ (Note 1)	I_D	$T_C=25^\circ\text{C}$	25
		$T_C=100^\circ\text{C}$	17
Drain Current, Pulsed (Note 2)	I_{DM}	50	A
Single Avalanche Energy @ $L=0.5\text{mH}$	E_{AS}	68	mJ
Power Dissipation (Note 3)	P_D	30	W
Operating Junction/ Storage Temperature Range	T_J / T_{STG}	-55 to +150	$^\circ\text{C}$

Note 1: Continuous current tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

Note 2: Repetitive rating; pulse width limited by max. junction temperature.

Thermal Characteristics

Parameter	Symbol	Max	Unit
Thermal Resistance Junction to Case (Note 3)	R_{thJC}	4.2	$^\circ\text{C/W}$

Note 3: The power dissipation P_D is based on max. junction temperature, using junction-to-case thermal resistance.

Electrical Characteristics (T_J =25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	30	--	--	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V	--	--	1.0	uA
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _{DS} =250uA	1.0	--	2.5	V
Gate Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
Drain-Source On-state Resistance	R _{DS(on)}	V _{GS} =10V, I _D =15A	--	6.7	10	mΩ
		V _{GS} =4.5V, I _D =10A	--	12	16	
Total Gate Charge	Q _g	I _D = 15A, V _{DS} =15V, V _{GS} = 10V	--	12	--	nC
Gate-Source Charge	Q _{gs}		--	3	--	
Gate-Drain Charge	Q _{gd}		--	4	--	
Turn-on Delay Time	t _{d(on)}	V _{GS} =10V, V _{DD} =22V, I _D =10A, R _G =2.2Ω	--	8.3	--	ns
Turn-on Rise Time	t _r		--	19.3	--	
Turn-off Delay Time	t _{d(off)}		--	23.1	--	
Turn-off Fall Time	t _f		--	5.5	--	
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =25V, f=1MHz	--	960	--	pF
Output Capacitance	C _{oss}		--	144	--	
Reverse Transfer Capacitance	C _{rss}		--	120	--	

Reverse Diode Characteristics (T_J =25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Continuous Source Current (Body Diode)	I _S	T _C =25°C	--	--	25	A
Pulsed Source Current (Body Diode)	I _{SM}		--	--	50	
Diode Forward Voltage	V _{SD}	I _S =15A, V _{GS} =0V	--	--	1.2	V
Reverse Recovery Time	T _{rr}	I _F =10A, di/dt = 100 A/μs	--	12	--	ns
Reverse Recovery Charge	Q _{rr}		--	4	--	nC

Typical Characteristics Curves ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 - Typical Output Characteristics

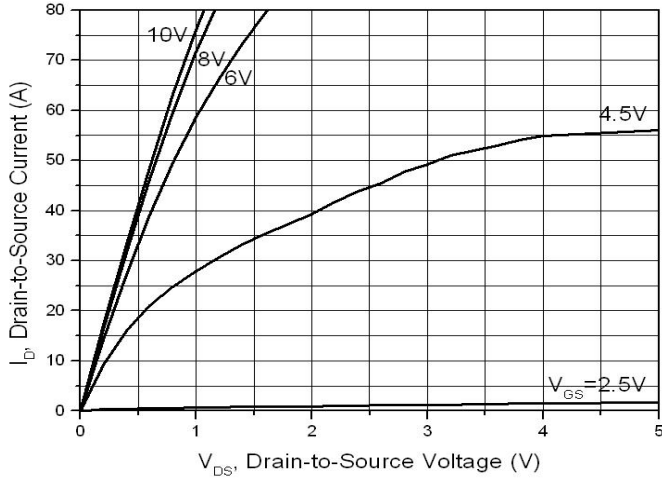


Fig.2 - BVDSS vs. Junction Temperature

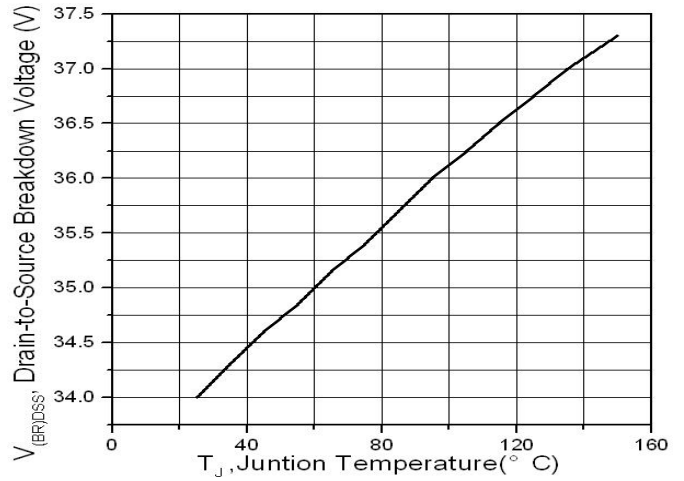


Fig.3 - Normalized On-Resistance vs. Junction Temperature

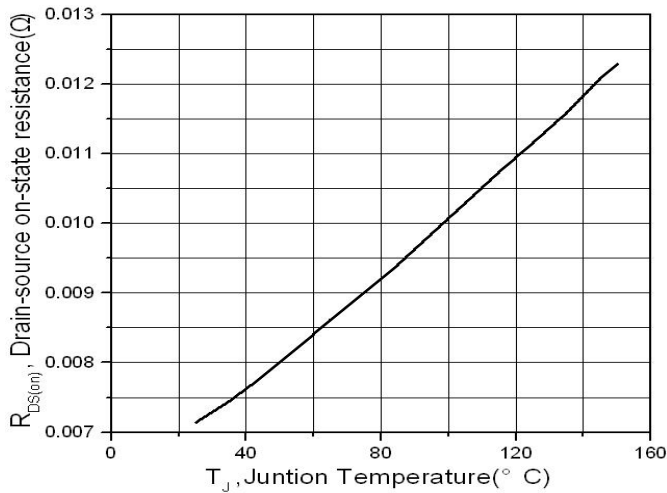


Fig.4 - Normalized $V_{GS(th)}$ vs. Junction Temperature

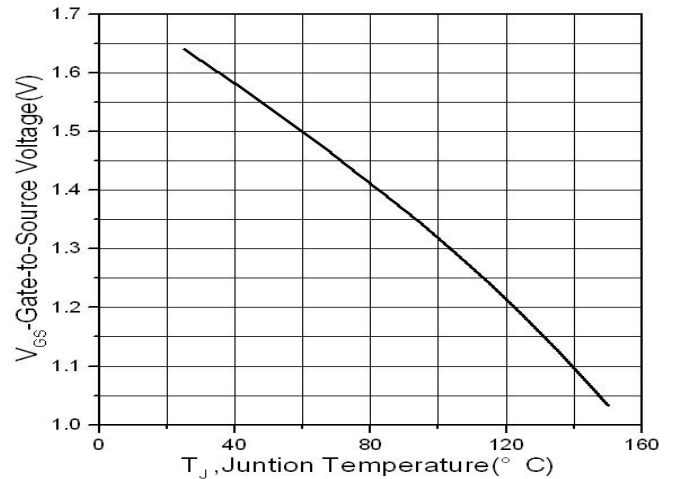


Fig.5 - Transfer Characteristics

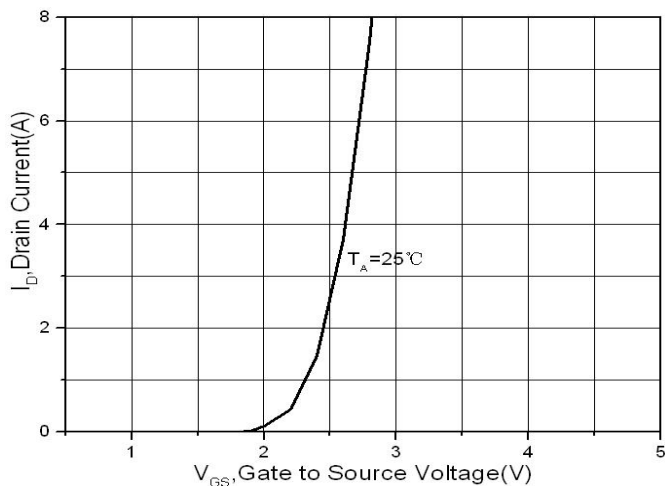
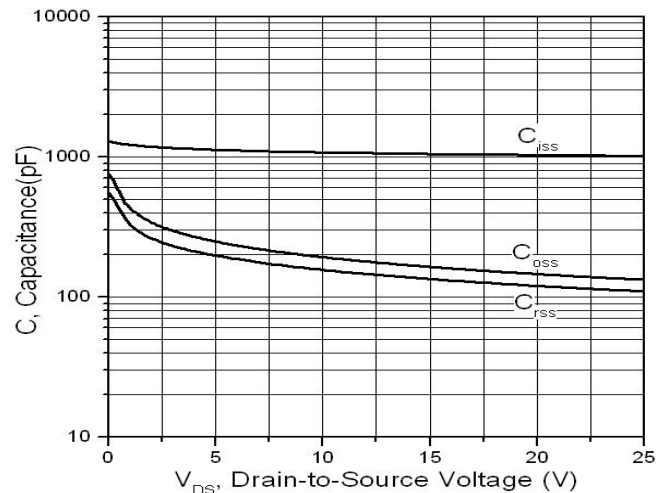


Fig.6 - Capacitance Characteristics



Typical Characteristics Curves ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Fig.7 - Safe Operation Area

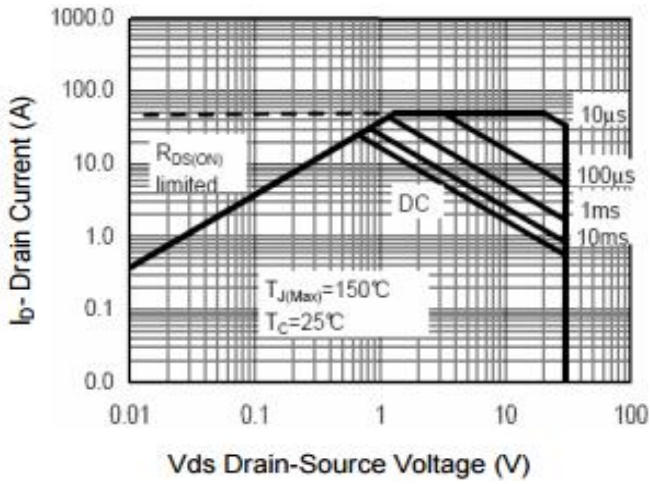
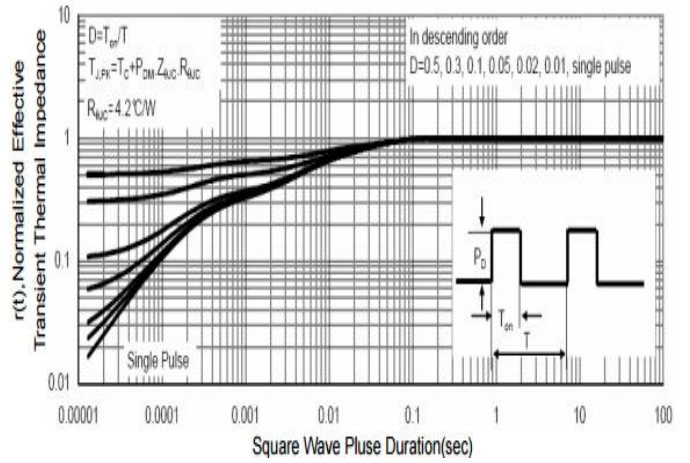
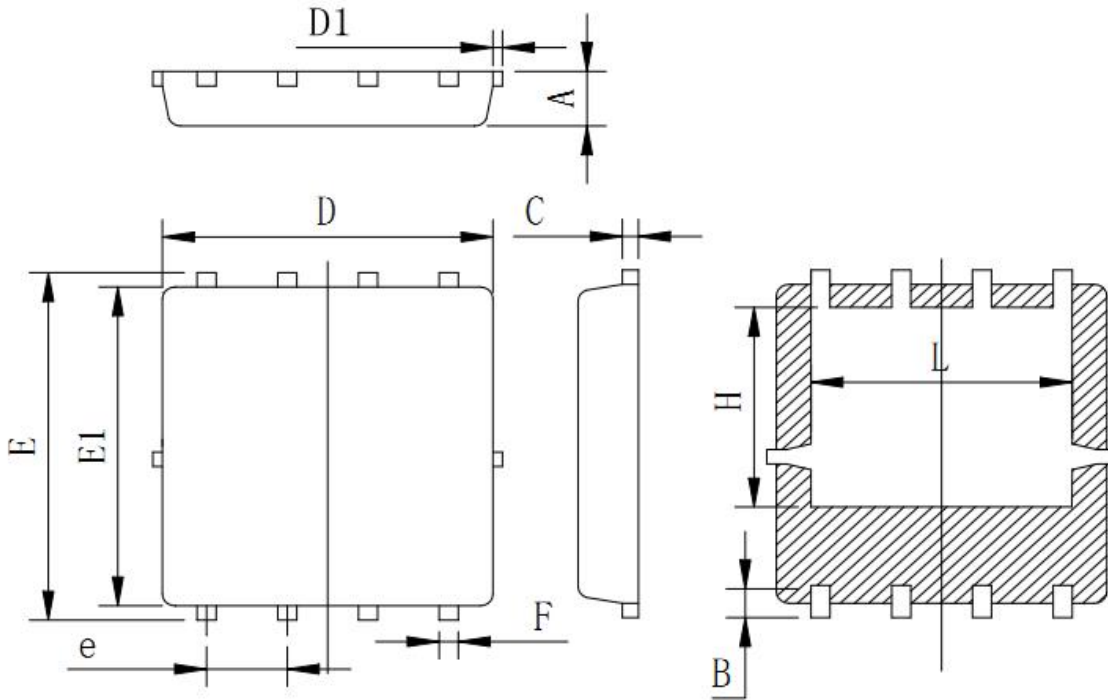


Fig.8 - Transient Thermal Impedance



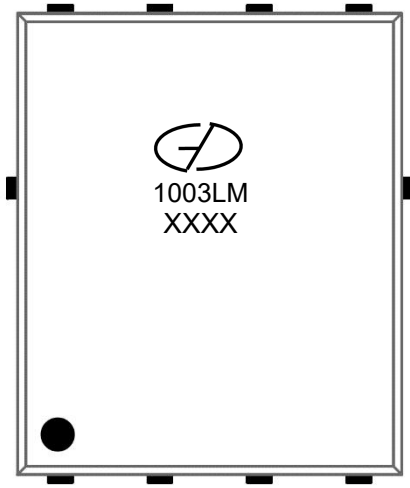
Package Outline Dimensions (Unit: millimeters)

PDFN5060



Symbol	Min	Typ	Max
A	0.90	0.95	1.00
B	0.48	0.58	0.68
C	0.20	0.254	0.30
D	5.00	5.20	5.40
D1			0.15
E	5.90	6.05	6.20
E1	5.40	5.55	5.70
e	1.22	1.27	1.32
F	0.25	0.30	0.35
H	3.27	3.47	3.67
L	3.80	4.00	4.20

Marking Outline



Part Name: GMN1003LM

1. Logo Mark: 
2. P/N Mark: 1003LM
3. Date Code: XXXX
4. Pin 1#: ●

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